DECLARATION and POWER OF ATTORNEY

As a below-named inventor, I declare that I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed in the specification identified below and for which a patent is sought on the invention as titled therein. I hereby state that I have reviewed and understand the contents of said specification including the claims, as amended by any amendment referred to herein. I acknowledge the duty to disclose to the Office all information known to me to be material to patentability as defined in 37 CFR § 1.56.

Full Name of Inventor(1)	Last Name UTSUNOMIYA	First Name Shin	Middle Name	
Residence & Citizenship	City Miyako-shi	State or Foreign Country IWATE	Country of Citizens JAPAN	hip
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Full Name of Inventor(2)	Last Name YAMADA	First Name Seigo	Middle Name	1
Residence & Citizenship	City Ichikawa-shi	State or Foreign Country CHIBA	Country of Citizens	nip
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Full Name of Inventor(3)	Last Name TAKANO	First Name Masahiro	Middle Name	
Residence & Citizenship	City Inba-gun	State or Foreign Country CHIBA	Country of Citizens	nip
Post Office Address	Post Office Address c/o Photosensitive Materials Research Center, Toyo Gosei Co., Ltd., 2-1, Wakahagi 4-chome, Inba-mura	City Inba-gun	State or Country JAPAN	Zip Code 270-1609
Full Name of Inventor(4)	Last Name MIYAZAKI	First Name Mitsuharu	Middle Name	
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Attorney's DECLAR	ATION AND POWER OF	ATTORNEY Pa	ge 2 Docket No	. ·
Full Name of Inventor(5)	Last Name	First Name	Middle Name	
Residence & Citizenship	City	State or Foreign Country	Country of Citizensh	ip
Post Office Address	Post Office Address	City	State or Country	Zip Code
Full Name of Inventor(6)	Last Name	First Name	Middle Name	
Residence & Citizenship	City	State or Foreign Country	Country of Citizensh	ip
Post Office Address	Post Office Address	City	State or Country	Zip Code
		14.		
Title of the Invention: Photosensitive	Resin Composition and M	lethod for Forming t	lydrogel	
🛚 Patent specificat	ion attached.			
Patent specificati and was amende	ion was filed on (if applicable).	as U.S. application Serial l	No	
☐ No earlier-filed fo	oreign applications of which priority bene	fit is claimed.		
Required informa	tion as to earlier-filed foreign application	s of which priority benefit is clai	med appears on page 2 a	ittached.
☐ No earlier-filed U	U.S. applications of which priority benefit	t is claimed.		
☐ Required informa	tion as to earlier-filed U.S. applications of	of which priority benefit is claime	ed appears on page 2 atta	ached.

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belief are believed to be true; and further tha like so made are punishable by fine or imprise willful false statements may jeopardize the value of Inventor(1) Shin UTSUNOMIYA Date April 1, 2005 Signature of Inventor(4) Mitsuharu MIYAZAKI Mitsuharu Miyazaki	Brian A. Gomez Huntley & Associates 1105 North Market Street PO Box 948 Wilmington, DE 19899-0948 herein of my own knowledge are true at these statements were made with tonment, or both, under Section 1001	Tel. No. (302) 426-0610 e and that all statements made on information the knowledge that willful false statements and of Title 18 of the United States Code, and that
Donald W. Huntley Send correspondence and direct telephone calls to: I further declare that all statements made belief are believed to be true; and further that like so made are punishable by fine or imprison willful false statements may jeopardize the value of Inventor(1) Shin UTSUNOMIYA Date April 1, 2005 Signature of Inventor(4) Mitsuharu MIYAZAKI	Brian A. Gomez Huntley & Associates 1105 North Market Street PO Box 948 Wilmington, DE 19899-0948 herein of my own knowledge are true to these statements were made with the comment, or both, under Section 1001 clidity of the application or any patent Signature of Inventor(2) Seigo YAMADA Seigo YAMADA Date April 1, 2005	Tel. No. (302) 426-0610 e and that all statements made on information the knowledge that willful false statements and of Title 18 of the United States Code, and that issuing thereon. Signature of Inventor(3) Masahiro TAKANO Masahiro Takano Date April /, 2005
Send correspondence and direct telephone calls to: I further declare that all statements made belief are believed to be true; and further that like so made are punishable by fine or imprise willful false statements may jeopardize the value of Inventor(1) Shin UTSUNOMIYA Date April 1, 2005 Signature of Inventor(4) Mitsuharu MIYAZAKI	Huntley & Associates 1105 North Market Street PO Box 948 Wilmington, DE 19899 0948 herein of my own knowledge are truet these statements were made with tonment, or both, under Section 1001 didity of the application or any patent Signature of Inventor(2) Seigo YAMADA Seigo YAMADA Date April 1, 3005	Tel. No. (302) 426-0610 e and that all statements made on information the knowledge that willful false statements and of Title 18 of the United States Code, and that issuing thereon. Signature of Inventor(3) Masahiro TAKANO Masahiro Takano Date April /, 2005
I further declare that all statements made belief are believed to be true; and further that like so made are punishable by fine or imprise willful false statements may jeopardize the value of Inventor(1) Shin UTSUNOMIYA Date April 1, 2005 Signature of Inventor(4) Mitsuharu MIYAZAKI	Huntley & Associates 1105 North Market Street PO Box 948 Wilmington, DE 19899 0948 herein of my own knowledge are truet these statements were made with tonment, or both, under Section 1001 didity of the application or any patent Signature of Inventor(2) Seigo YAMADA Seigo YAMADA Date April 1, 3005	e and that all statements made on information the knowledge that willful false statements and of Title 18 of the United States Code, and that issuing thereon. Signature of Inventor(3) Masahiro TAKANO Masahiro Takano Date April /, 2005
belief are believed to be true; and further tha like so made are punishable by fine or imprise willful false statements may jeopardize the value of Inventor(1) Shin UTSUNOMIYA Date April 1, 2005 Signature of Inventor(4) Mitsuharu MIYAZAKI	at these statements were made with tonment, or both, under Section 1001 clidity of the application or any patent Signature of Inventor(2) Seigo YAMADA Seigo YAMADA Date April 1, 3005	the knowledge that willful false statements and of Title 18 of the United States Code, and that issuing thereon. Signature of Inventor(3) Masahiro TAKANO Masahiro Takano Date April /, 2005
Shin UTSUNOMIYA The Column of Inventor (4) Signature of Inventor (4) Mitsuharu MIYAZAKI	Seigo YAMADA Seigo Yamada Date april 1, 3005	Masahiro Takano Date April /, 2005
Signature of Inventor(4) Mitsuharu MIYAZAKI		Date April 1, 2005
Signature of Inventor(4) Mitsuharu MIYAZAKI		
Mitsuharu MIYAZAKI	Signature of Inventor(5)	
mitsufaru miyazaki		
Tropogation Thopogation		
Date April 1, 2005	Date	Date
	under Title 35, United States Code, lso identified below any foreign appl	nefit is claimed. § 119 of any foreign application(s) for patentication for patent or inventor's certificate having
Country Application 1 JAPAN 2002-33126		Priority Claimed (Yes-No) 2 Yes
☐ Required information as to earlier-filed U.S.	S. applications of which priority benefi	it is claimed.
the subject matter of each of the claims of this by the first paragraph of Title 35, United State	application is not disclosed in the prices Code, § 112. I acknowledge the din 37 CFR § 1.56, which became avail	ted States application(s) listed below and insofa or United States application in the manner prov uty to disclose to the Office all information know lable between the filing date of the prior applica
U.S. Application Serial No.	U.S.Filing Date	Status (patented, pending or abandoned)